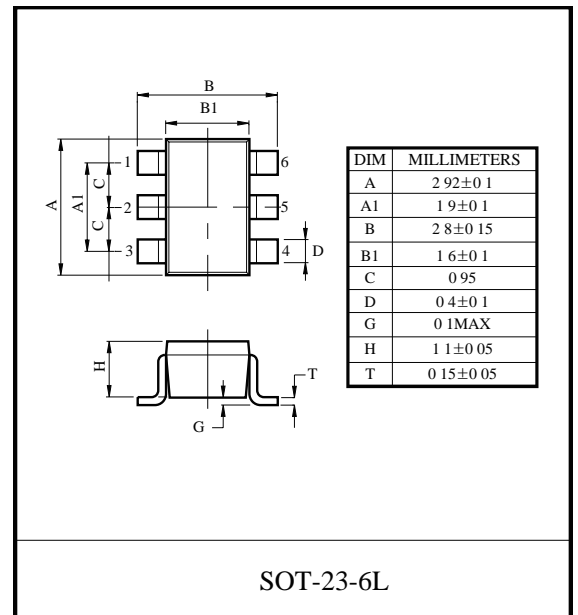


P-Channel 20-V(D-S) MOSFET

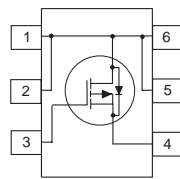
FEATURE

- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for extremely Low $R_{DS(on)}$

This P-Channel MOSFET is produced using advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance. These devices have been designed to offer exceptional power dissipation in a very small footprint for applications where the larger packages are impractical.



MARKING:



Maximum ratings ($T_a=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|---|-----------------|-----------|---------------------------|
| Drain-Source Voltage | V_{DS} | -20 | V |
| Continuous Gate-Source Voltage | V_{GS} | ±8 | |
| Continuous Drain Current | I_D | -4 | A |
| Power Dissipation | P_D | 0.35 | W |
| Thermal Resistance from Junction to Ambient | $R_{\theta JA}$ | 357 | $^\circ\text{C}/\text{W}$ |
| Operating Temperature | T_j | 150 | $^\circ\text{C}$ |
| Storage Temperature | T_{stg} | -55 ~+150 | |

**Electrical characteristics (T_a=25°C unless otherwise noted)**

| Parameter | Symbol | Test Condition | Min | Typ | Max | Units |
|--|----------------------|---|-------|-----|-------|-------|
| Off characteristics | | | | | | |
| Drain-source breakdown voltage | V _{(BR)DSS} | V _{GS} = 0V, I _D = -250μA | -20 | | | V |
| Gate-body leakage | I _{GSS} | V _{DS} = 0V, V _{GS} = ±8V | | | ±100 | nA |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = -16V, V _{GS} = 0V | | | -1.0 | μA |
| On characteristics | | | | | | |
| Gate-threshold voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = -0.25mA | -0.40 | | -1.50 | V |
| Static drain-source on-resistance (note 1) | R _{DS(on)} | V _{GS} = -4.5V, I _D = -4A | | | 0.065 | Ω |
| | | V _{GS} = -2.5V, I _D = -3.2A | | | 0.10 | |
| Forward transconductance (note 1) | g _{fs} | V _{DS} = -5V, I _D = -4A | 8 | | | S |
| Dynamic characteristics (note 2) | | | | | | |
| Input capacitance | C _{iss} | V _{DS} = -10V, V _{GS} = 0V, f = 1MHz | | 640 | | pF |
| Output capacitance | C _{oss} | | | 180 | | |
| Reverse transfer capacitance | C _{rss} | | | 90 | | |
| Switching characteristics | | | | | | |
| Turn-on delay time (note 1,2) | t _{d(on)} | V _{GS} = -4.5V, V _{DD} = -10V, I _D = -1A, R _{GEN} = 6Ω | | 20 | | ns |
| Rise time (note 1,2) | t _r | | | 30 | | |
| Turn-off delay time (note 1,2) | t _{d(off)} | | | 42 | | |
| Fall time (note 1,2) | t _f | | | 55 | | |
| Drain-source body diode characteristics | | | | | | |
| Body diode forward voltage (note 1) | V _{SD} | I _S = -1.3A, V _{GS} = 0V | | | -1.2 | V |

Notes:

1. Pulse Test ; Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
2. These parameters have no way to verify.

Typical Characteristics

